

## 60A, 650V SUPER JUNCTION MOS POWER TRANSISTOR

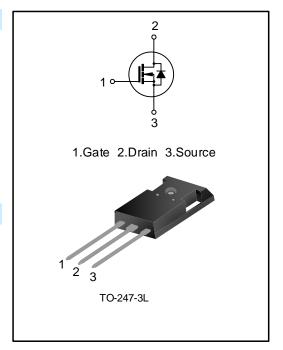
#### **DESCRIPTION**

SVSP65R050P7HD4 is an N-channel enhancement mode high voltage power MOSFETs produced using Silan's super junction MOS technology. It achieves low conduction loss and switching losses. It leads the design engineers to their power converters with high efficiency, high power density, and superior thermal behavior.

Furthermore, it's universal applicable, i.e., suitable for hard and soft switching topologies.

#### **FEATURES**

- 60A, 650V,  $R_{DS(on)(typ.)}$ =42m $\Omega@V_{GS}$ =10V
- New revolutionary high voltage technology
- Ultra low gate charge
- Periodic avalanche rated
- Extreme dv/dt rated
- High peak current capability
- 100% avalanche tested
- Pb-free lead plating
- RoHS compliant



## **KEY PERFORMANCE PARAMETERS**

Characteristics	Ratings	Unit
V <sub>DS</sub>	650	V
V <sub>GS(th)</sub>	3.0~5.0	V
R <sub>DS(on),max.</sub>	50	mΩ
I <sub>D.pulse</sub>	200	Α
Q <sub>g.typ.</sub>	139	nC

#### **ORDERING INFORMATION**

Part No.	Package	Marking	Hazardous Substance Control	Packing Type
SVSP65R050P7HD4	TO-247-3L	P65R050P7	Halogen free	Tube

HANGZHOU SILAN MICROELECTRONICS CO.,LTD http://www.silan.com.cn Page 1 of 10



## ABSOLUTE MAXIMUM RATINGS (UNLESS OTHERWISE NOTED, TJ=25°C)

Obanastanistias	Course of	Test conditions	Ratings			Unit
Characteristics	Symbol	rest conditions	Min.	Тур.	Max.	Onit
Drain-source Voltage	V <sub>DS</sub>				650	V
Gate-source Voltage (Static)	V <sub>GS</sub>		-20		20	V
Gate-source Voltage (Dynamic)	V <sub>GS</sub>	AC(f>1 Hz)	-30		30	V
Drain Current	1	T <sub>C</sub> =25°C			60	Α
Drain Current	Ι <sub>D</sub>	T <sub>C</sub> =100°C			38	Α
Drain Current Pulsed (Note 1)	I <sub>DM</sub>	T <sub>C</sub> =25°C			200	Α
Power Dissipation (Note 2)	P <sub>D</sub>	T <sub>C</sub> =25°C			446	W
Single Pulsed Avalanche Energy	E <sub>AS</sub>	L=79mH, $V_{DD}$ =100V, $R_{G}$ =25 $\Omega$ , starting temperature $T_{J}$ =25 $^{\circ}$ C			2646	mJ
Single Pulsed Current	I <sub>AS</sub>				7.6	А
Reverse Diode dv/dt	dv/dt	V <sub>DS</sub> =0~400V, I <sub>SD</sub> <= I <sub>S</sub> , T <sub>J</sub> =25°C			50	V/ns
MOSFET dv/dt Ruggedness	dv/dt	V <sub>DS</sub> =0~400V			50	V/ns
Operation Junction Temperature Range	Тл		-55		150	°C
Storage Temperature Range	T <sub>stg</sub>		-55		150	°C
Continuous Diode Forward Current	Is	T <sub>C</sub> =25°C, integral reverse P-N			60	А
Diode Pulse Current	I <sub>S</sub> , <sub>pulse</sub>	junction diode in the MOSFET			200	Α
Maximum Diode Commutation Speed	di/dt	V <sub>DS</sub> =0~400V, I <sub>SD</sub> <= I <sub>S</sub> , T <sub>J</sub> =25°C			900	A/µs

## THERMAL CHARACTERISTICS

Characteristics	Symbol	Test conditions	Ratings			Unit
	Symbol	rest conditions	Min.	Тур.	Max.	Offic
Thermal Resistance,	$R_{\theta,JC}$				0.28	°C/W
Junction-case, Bottom	NθJC				0.20	0,11
Thermal Resistance,	$R_{\theta JA}$				50	°C/W
Junction-ambient					30	0
Soldering Temperature (in line)	Tsold	15 <sup>+2</sup> <sub>-0</sub> sec, 1time			260	°C

Rev.:1.1 http://www.silan.com.cn Page 2 of 10



## ELECTRICAL CHARACTERISTICS (UNLESS OTHERWISE NOTED,TJ=25°C)

#### Static characteristics

Characteristics	Symbol Test conditions –	Ratings			Unit	
Characteristics		Min.	Тур.	Max.	Offic	
Drain-source Breakdown	BV <sub>DSS</sub>	V <sub>GS</sub> =0V, I <sub>D</sub> =250μA	650			V
Voltage	DVDSS	V <sub>GS</sub> =0 V, I <sub>D</sub> =230μA	030			V
Drain gourge Leekage Current	I <sub>DSS</sub>	V <sub>DS</sub> =650V, V <sub>GS</sub> =0V, T <sub>J</sub> =25°C			1.0	
Drain-source Leakage Current		V <sub>DS</sub> =650V, V <sub>GS</sub> =0V, T <sub>J</sub> =125°C		14		μΑ
Gate-source Leakage Current	I <sub>GSS</sub>	V <sub>GS</sub> =±20V, V <sub>DS</sub> =0V			±100	nA
Gate Threshold Voltage	$V_{GS(th)}$	$V_{GS}=V_{DS}$ , $I_{D}=250\mu A$	3.0		5.0	V
Static Drain-source	D	V <sub>GS</sub> =10V, I <sub>D</sub> =30A, T <sub>J</sub> =25°C		42	50	mΩ
On State Resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> =10V, I <sub>D</sub> =30A, T <sub>J</sub> =150°C		102		mΩ
Gate Resistance	R <sub>G</sub>	f=1MHz		2.0		Ω

### **Dynamic characteristics**

Characteristics	Sumbol	Symbol Test conditions	Ratings			l lmi4
Characteristics	Symbol		Min.	Тур.	Max.	Unit
Input Capacitance	C <sub>iss</sub>	£ 4141 - \/ O\/		6286		
Output Capacitance	Coss	f=1MHz, V <sub>GS</sub> =0V,		165		pF
Reverse Transfer Capacitance	C <sub>rss</sub>	V <sub>DS</sub> =200V		7.2		
Turn-on Delay Time	t <sub>d(on)</sub>	V 400V V 40V D 400		35		
Turn-on Rise Time	t <sub>r</sub>	$V_{DD}$ =400V, $V_{GS}$ =13V, $R_{G}$ =1.8 $\Omega$ ,		37		l
Turn-off Delay Time	t <sub>d(off)</sub>	I <sub>D</sub> =44.2A (Notes 2, 4)		99		ns
Turn-off Fall Time	t <sub>f</sub>	(Notes 3, 4)		24		
Total Gate Charge	$Q_g$	V 400V V 40V		139		
Gate-source Charge	$Q_{gs}$	$V_{DD}$ =480V, $V_{GS}$ =10V,		52		nC
Gate-drain Charge	$Q_{gd}$	I <sub>D</sub> =44.2A (Notes 3, 4)		57		
Gate-plateau Voltage	V <sub>plateau</sub>	(Notes 3, 4)		7.6		V

#### Reverse diode characteristics

Characteristics	Symbol	Test conditions	Ratings			Unit
Characteristics	Symbol	rest conditions	Min.	Тур.	Max.	Offic
Diode Forward Voltage	V <sub>SD</sub>	I <sub>S</sub> =44.2A, V <sub>GS</sub> =0V			1.4	V
Reverse Recovery Time	T <sub>rr</sub>	I <sub>S</sub> =44.2A, V <sub>GS</sub> =0V, V <sub>R</sub> =400V,		155		ns
Reverse Recovery Charge	Qrr	dI <sub>F</sub> /dt=100A/µs		1.1		μC
Reverse Recovery Peak Current	I <sub>rrm</sub>	(Note 3)		13		Α

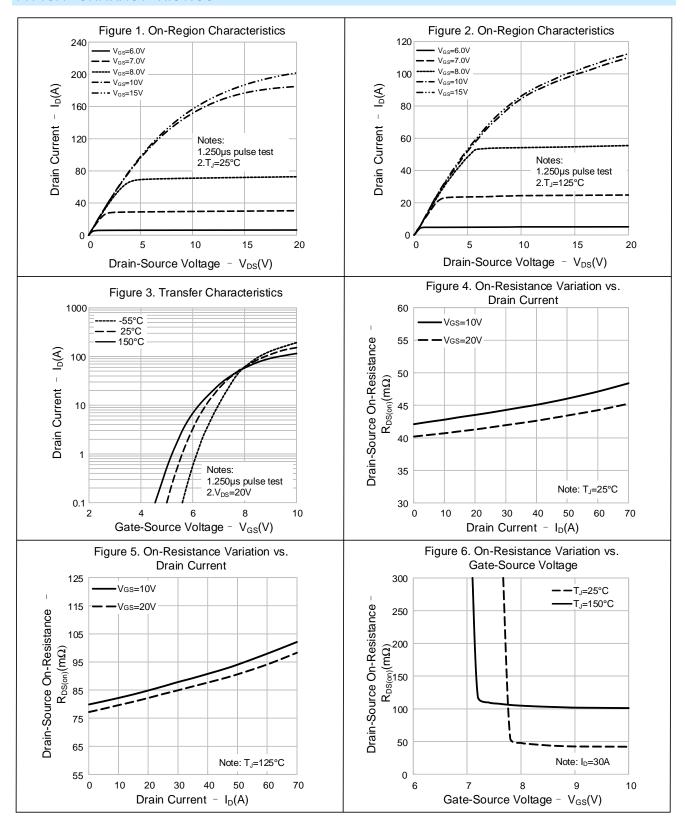
#### Notes:

- Pulse time 5µs; 1.
- 2. The dissipation power will change with temperature, derating above 25°C: 3.57W/°C;
- Pulse Test: Pulse width ≤300µs, Duty cycle≤2%;
- Essentially independent of operating temperature.

Rev.:1.1 http://www.silan.com.cn Page 3 of 10



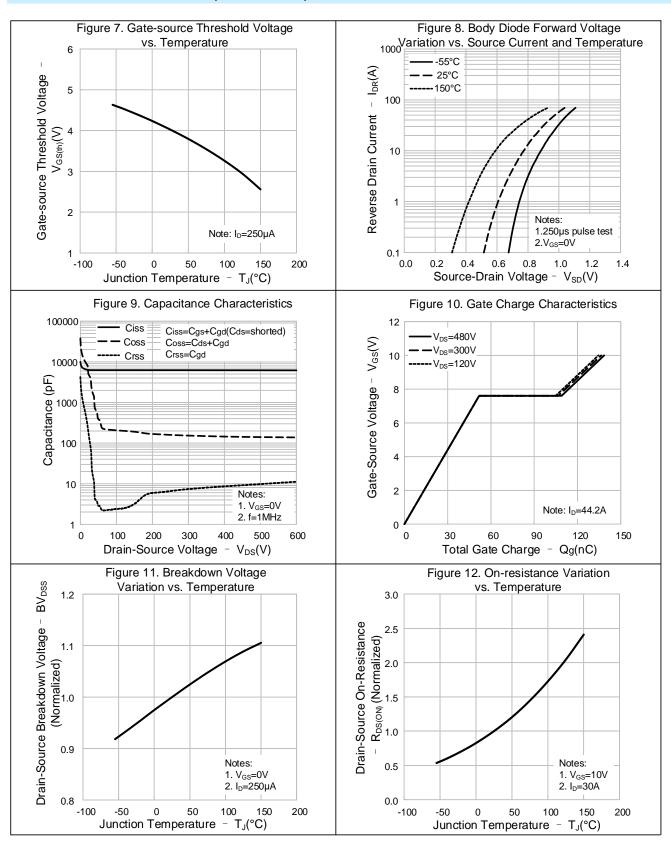
#### TYPICAL CHARACTERISTICS



Rev.:1.1 http://www.silan.com.cn



### TYPICAL CHARACTERISTICS (CONTINUED)

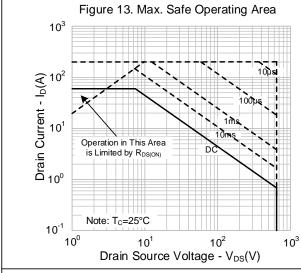


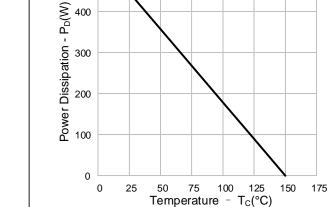
http://www.silan.com.cn

Figure 14. Power Dissipation vs. Temperature

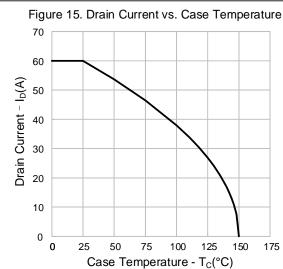


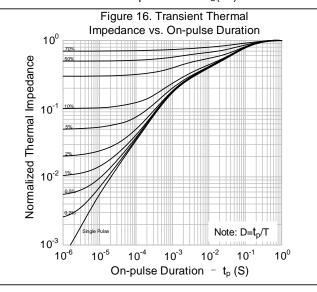
## **TYPICAL CHARACTERISTICS (CONTINUED)**





500



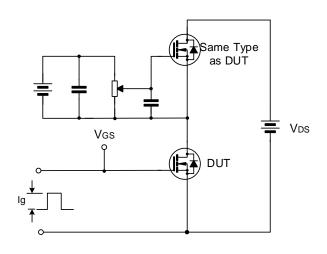


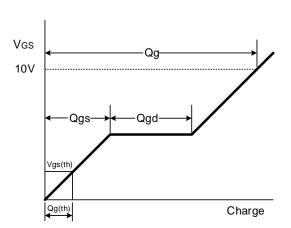
http://www.silan.com.cn Page 6 of 10



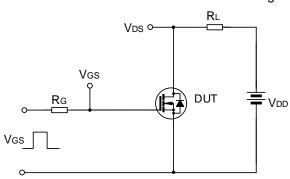
### **TYPICAL TEST CIRCUIT**

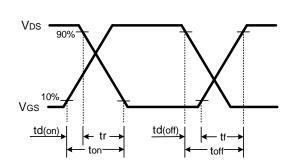
## Gate Charge Test Circuit & Waveform



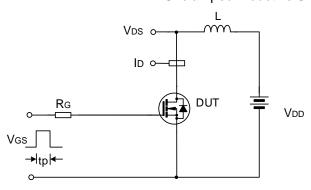


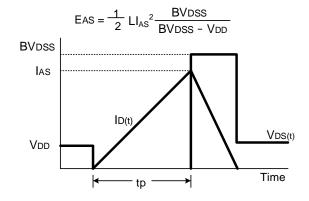
## Resistive Switching Test Circuit & Waveform





## Unclamped Inductive Switching Test Circuit & Waveform

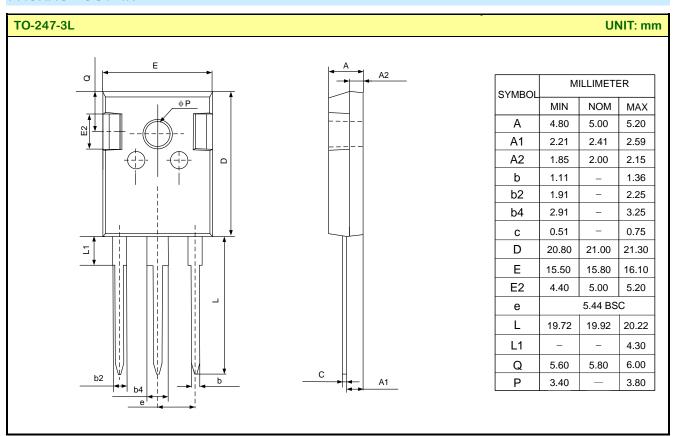




Rev.:1.1 Page 7 of 10



#### **PACKAGE OUTLINE**





## **MOS DEVICES OPERATE NOTES:**

Electrostatic charges may exist in many things. Please take following preventive measures to prevent effectively the MOS electric circuit as a result of the damage which is caused by discharge:

- The operator must put on wrist strap which should be earthed to against electrostatic.
- Equipment cases should be earthed.
- All tools used during assembly, including soldering tools and solder baths, must be earthed.
- MOS devices should be packed in antistatic/conductive containers for transportation.

Rev.:1.1



#### Important notice:

- Silan reserves the right to make changes of this instruction without notice.
- 2. Customers should obtain the latest relevant information when purchasing and should verify whether such information is latest and complete. Please read this instruction and application manual and related materials carefully before using products, including the circuit operation precautions, etc.
- It is neither tested nor verified in accordance with AEC-Q series standards testing or application requirements. Silan does not give any warranties as to the suitability of the Silan's product for any specific use. The design intent, design definition and design of the product are not intended for application (the application stated in this instruction includes use, etc.) in transportation equipment, medical equipment, life-saving equipment, aerospace equipment, non-civil equipment or non-civil use, etc. (the equipment stated in this instruction includes systems, devices, etc., all referred to as equipment). The product should not be used in any equipment or system whose manufacture, use or sale is prohibited under any applicable laws or regulations("unintended use"). If the product is used for unintended use, therefore the full risks of such products application are borne by the customer and Silan assumes no liability for the product used for the unintended use. If the customer intends to use the Silan's product in a application where malfunction or failure can be reasonably be expected to result in personal injury, or serious property, or environment damage, the customer shall make adequate assessment, testing and verification, and Silan shall not be liable for such applications.
- The application of the product described in this instruction, the application manual of the product and related materials is for illustrative purposes only, and Silan makes no warranty that such application can be used directly without further testing, verification or modification. Silan is not responsible for any assistance in product application or customers' product design. Customer shall be responsible for the application of Silan's products and the design, manufacture and use of customers' products using Silan's products (in this document, "use products", "apply Silan's products", "product application" and "customers' products using Silan's products" are synonymous). It is the sole responsibility of the customer to take the following actions: 1) Verify and determine whether Silan's products are suitable for the customers' applications and customers' products; 2) All applicable standards of the customers' industry shall be complied with and fully tested and verified when applying Silan's product or using Silan's product to develop and design customers' products; 3) Although Silan is constantly committed to improve product's quality and reliability, semiconductor products have possibility to malfunction or fail in various application environments. Customers are responsible for complying with safety standards and for providing adequate designs and safeguards for customers' products using Silan's product to minimize risks and avoid situations in which a malfunction or failure could cause bodily injury or damage to property; 4) When using the products, please do not exceed the maximum rating of the products, Stress above one or more limiting values will cause damage to the product and the equipment or affect the reliability to the equipment (customers' product); 5) Ensure customers' product using Silan's product are designed, manufactured and used in full compliance with all applicable standards, safety standards and other requirements of the customers' industry. The parameters stated in this instruction may and do vary in different applications, actual performance may vary over time, and customers must use the products within their effective static storage period (within one year from the delivery date of Silan). Customer should confirm the effective static storage period of the product if purchasing from a third party. Silan does not assume any responsibility if the product has exceeded the static storage period when it is used.
- Do not disassemble, reverse-engineer, alter, modify, decompile or copy product, without Silan's prior written consent.
- Please identify Silan's trademark when purchasing our product. Please contact us if there is any question. Our products are not sold through TAOBAO or any other third-party e-commerce platforms. If customers purchase from such platforms, please contact us in writing before purchasing to confirm whether the product is authentic and original from Silan.
- 7. Please use and apply product in compliance with all applicable laws and regulations, including but not limited to trade control regulations etc. The product is civil electronic product, please do not use it in non-civil fields.
- 8. Product promotion is endless, our company will wholeheartedly provide customers with better products!
- Website: http://www.silan.com.cn

Rev.:1.1 http://www.silan.com.cn Page 9 of 10



SVSP65R050P7HD4 Part No.: Document Type: Datasheet

Copyright: HANGZHOU SILAN MICROELECTRONICS CO.,LTD Website: http://www.silan.com.cn

Rev.: 1.1

Revision History:

Modify some parameters

Rev.: 1.0 Revision History:

First release

Rev.:1.1 http://www.silan.com.cn Page 10 of 10